



THE HONG KONG
INSTITUTION OF ENGINEERS
香港工程師學會

Smart City Conference 2021 – “Smart Infrastructure Conference”

Sponsor Invitation Reply Slip

Please return this reply slip by email to sic2021@ust.hk.

A. Company and Contact Person Information:

Company /

Organisation: _____

(Please provide full English name as it would appear on all promotional materials of the event.)

Contact Person: _____

Position: _____

Email _____

Contact Tel No.: _____

Address: _____

B. Sponsorship Package:

We shall sponsor the summit in the amount of: (Please ✓ in the appropriate box.)

Diamond (HK\$ 20,000)

Platinum (HK\$ 10,000)

Gold (HK\$5,000)

We are not able to sponsor this year.

Please send me the invoice / receipt for the sponsorship payment.

**Please note that there is no refund for any cancellation of sponsorship after the payment.*

C. Payment Method:

1. By Cheque

Please mail this reply slip with crossed cheque payable to “**Hong Kong University of Science and Technology Civil and Environmental Engineering Alumni Association**” to:

SIC 2021 Event Secretariat (Minerals Creations & Communications Ltd.)

3G, Wah Hing Industrial Mansions, 36 Tai Yau Street, San Po Kong, Kowloon, Hong Kong

2. By Bank Transfer

Please refer to below bank account details for the payment and send the bank-in slip by email to:

sic2021@ust.hk as record.

Bank: Hang Seng Bank Limited **Bank Code:** 024 **Bank Account No:** 379-237563-001

Bank Account Name: Hong Kong University of Science and Technology Civil and Environmental Engineering Alumni Association

F. Confirmation:

Authorized Signature with Company Chop

Date

Enquires: Ms. Kimi LIU / Ms Connie Kwong (Event Secretariat) Tel: +852 3502-4983 E-mail:
sic2021@ust.hk